( ) Preliminary Specifications
(V) Final Specifications

Module	**14.0" (13.98") HD+ 16:9 Color TFT-LCD with LED Backlight design**
Model Name	**B140RTN01.0 (H/W:0A)**
Note ( )	***LED Backlight with driving circuit design***

Customer	**Date**
HP	11/10/2011
Checked & Approved by	**Date**
Note: This Specification is subject to change without notice.	

Approved by	**Date**
Claire Yu	11/10/2011
Prepared by	**Date**
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NBBU Marketing Division AU Optronics corporation	

Contents

Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2011/05/19	All	First Edition for Customer		
0.2 2011/05/31	24-25	TBD	Update 2D drawing	
	26	TBD	Update label information	
0.3 2011/07/21	5	TBD	Update general specification	
	13	Power specification TBD	Update power specification	
	15	LED characteristics TBD	Update LED characteristics	
		BLU input signal characteristics TBD	Update input signal characteristics	
	19	Connector TBD	Update connector	
	20	Timing characteristics TBD	Update timing characteristics	
	28-31	EDID TBD	Update EDID	
0.4 2011/08/16	28-31	Check sum 7F	Check sum 1D	
0.5 2011/08/17	5	Power Consumption 5.8W	Power Consumption 4.8W	
	15	Backlight Power Consumption 4.3W	Backlight Power Consumption 3.3W	
0.6 2011/09/05	6	Color Chromaticity = TBD	Update design data	
	22	Original Timing diagram Power Sequence Timing T9 & T10 Max = 180 T1 to T12	Update Timing diagram Power Sequence Timing T9 & T10 Max = - add T13 &T14 w/ explaination	
0.7 2011/09/15	5	White Luminance typ= 255	White Luminance typ= 250	
	20	Vertical blanking typ =12 Horizontal Blanking typ = 410	Vertical blanking typ =26 Horizontal Blanking typ = 340	
	28-31	EDID (255 nits setup)	EDID (250 nits setup)	
1.0 2011/11/10	All		Final Version for customer	

1. Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.
2) Be sure to turn off power supply when inserting or disconnecting from input connector.
3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
7) Do not open nor modify the Module Assembly.
8) Do not press the reflector sheet at the back of the module to any directions.
9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.

2. General Description

B140RTN01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1600(H) x900(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B140RTN01.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 ℃ condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	354.95			
Active Area	[mm]	309.60 X 174.15			
Pixels H x V		1600x3(RGB) x 900			
Pixel Pitch	[mm]	0.1935X0.1935			
Pixel Format		R.G.B. Vertical Stripe			
Display Mode		Normally White			
White Luminance (I_{LED}=18mA) **(Note: ILED is LED current)**	[cd/m^2]	250 typ. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		400 (typ)			
Response Time	[ms]	8 typ / 16 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	4.8 max. (Include Logic and Blu power)			
Weight	[Grams]	325 max.			
Physical Size **Include bracket**	[mm]		Min.	Typ.	Max.
		Length	320.15	320.65	321.15
		Width	198.20	198.70	199.20
		Thickness			3.40
Electrical Interface		2 channel LVDS			
Glass Thickness	[mm]	0.4			
Surface Treatment		Anti-Glare, Hardness 3H,			
Support Color		262K colors (RGB 6-bit)			

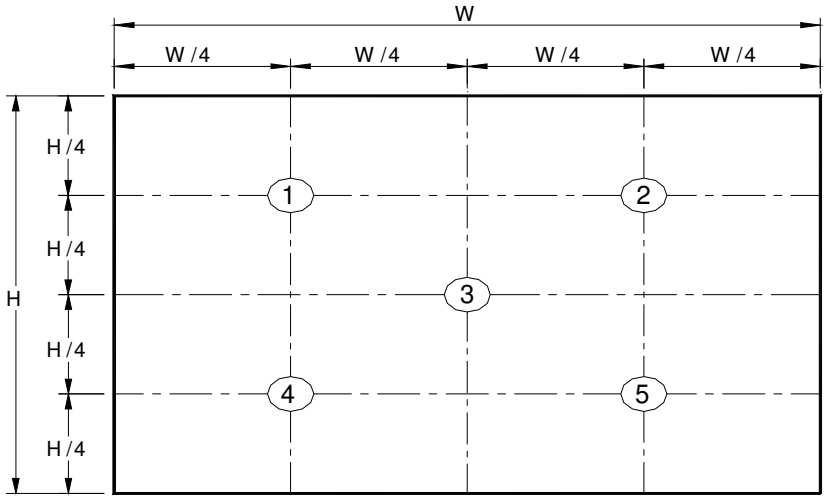
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

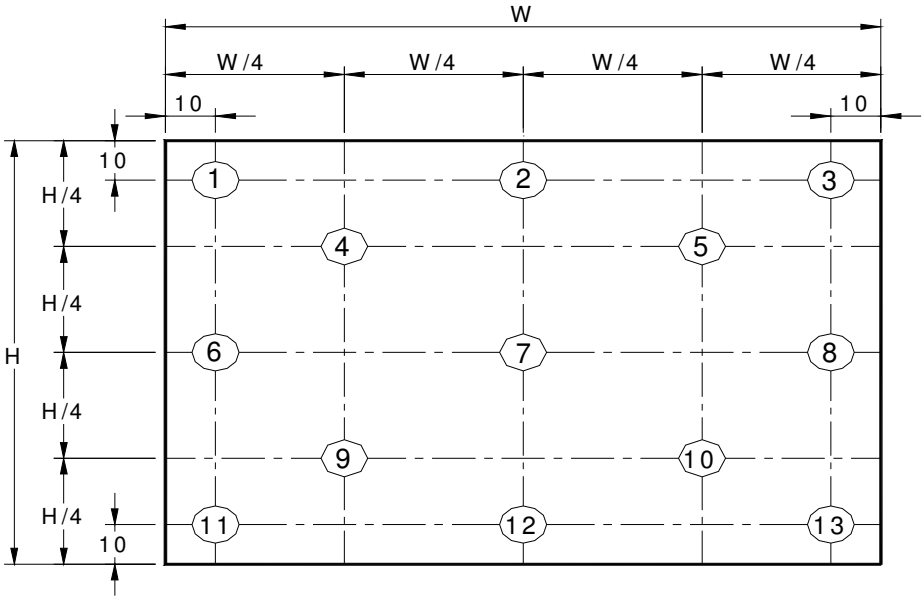
The optical characteristics are measured under stable conditions at 25℃ (Room Temperature) :

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance I_{LED}=18mA			5 points average	212	250	-	cd/m^2	1, 4, 5.
Viewing Angle		θ_R θ_L	Horizontal (Right) CR = 10 (Left)		70 70	- -	degree	4, 9
		ψ_H ψ_L	Vertical (Upper) CR = 10 (Lower)		60 60	- -		
Luminance Uniformity		δ_{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ_{13P}	13 Points	-	-	1.60		2, 3, 4
Contrast Ratio		CR		300	400	-		4, 6
Cross talk		%				4		4, 7
Response Time		T_r	Rising	-			msec	4, 8
		T_f	Falling	-				
		T_{RT}	Rising + Falling	-	8	16		
Color / Chromaticity Coodinates	Red	Rx	CIE 1931	0.610	0.640	0.670	-	4
		Ry		0.300	0.330	0.360		
	Green	Gx		0.270	0.300	0.330		
		Gy		0.570	0.600	0.630		
	Blue	Bx		0.120	0.150	0.180		
		By		0.030	0.060	0.090		
	White	Wx		0.283	0.313	0.343		
		Wy		0.299	0.329	0.359		
NTSC		%			72			

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

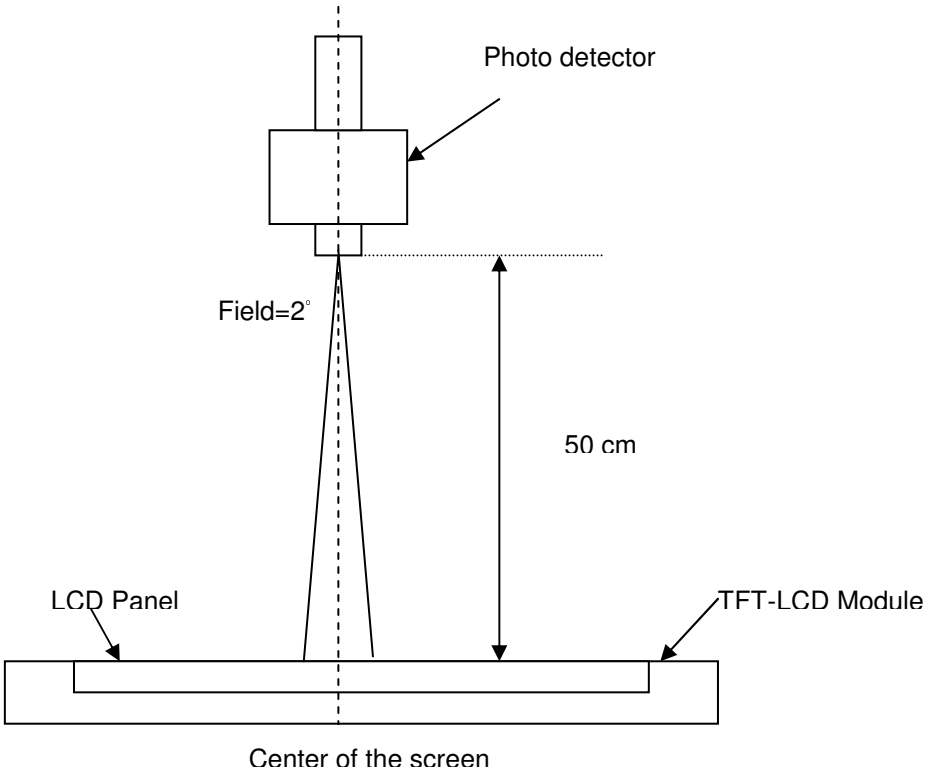
$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting

Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5 : Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , Y_L = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6 : Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the “White” state}}{\text{Brightness on the “Black” state}}$$

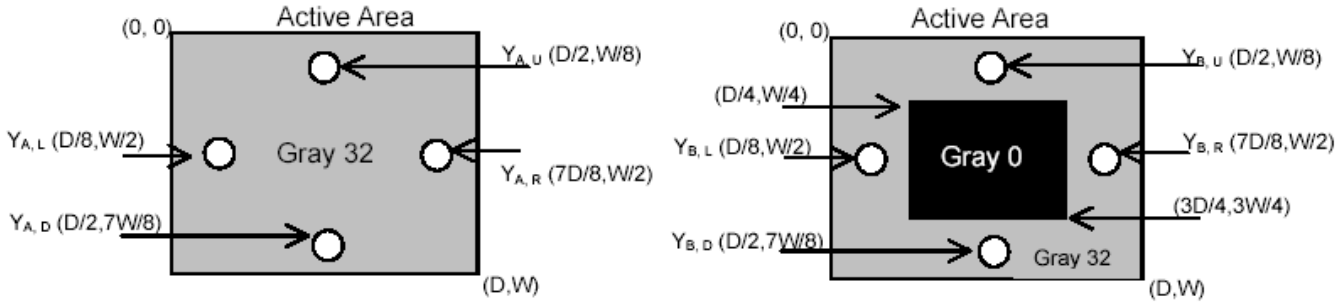
Note 7 : Definition of Cross Talk (CT)

$CT = | Y_B - Y_A | / Y_A \times 100\ (\%)$

Where

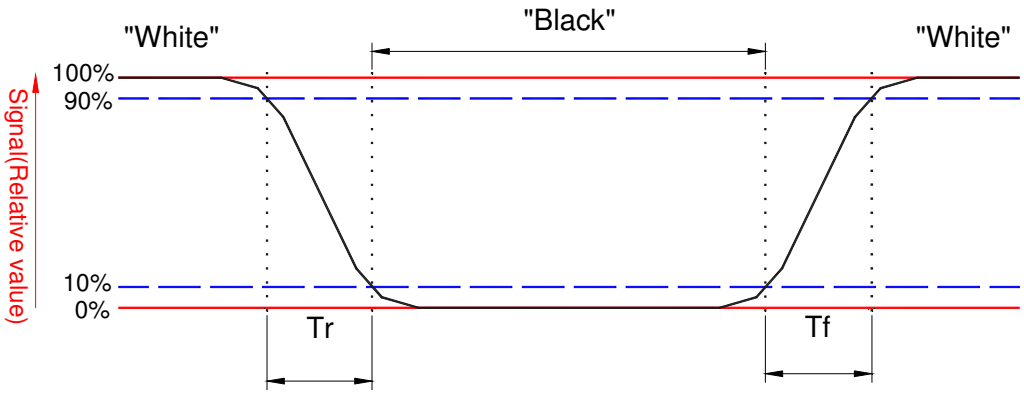
Y_A = Luminance of measured location without gray level 0 pattern (cd/m^2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m^2)



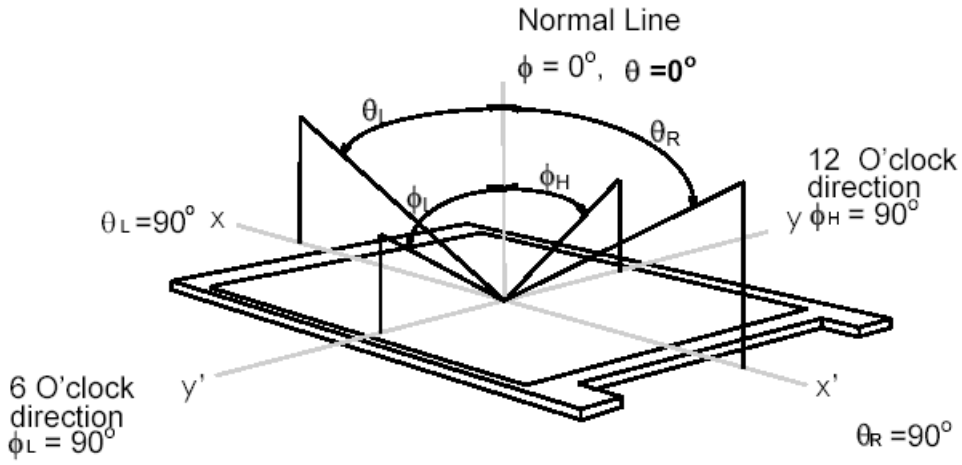
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from “Black” to “White” (falling time) and from “White” to “Black” (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



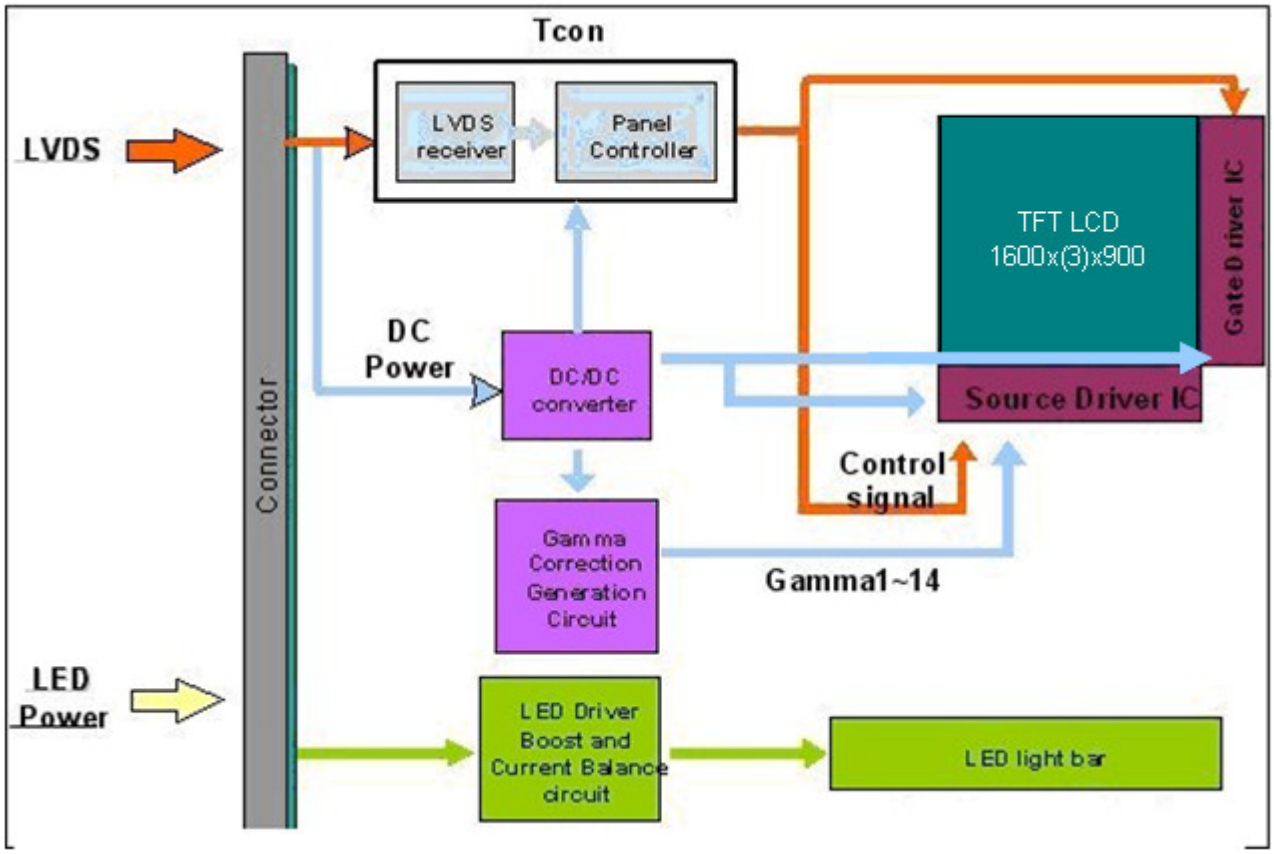
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≧ 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 40 Pin two channel Module



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

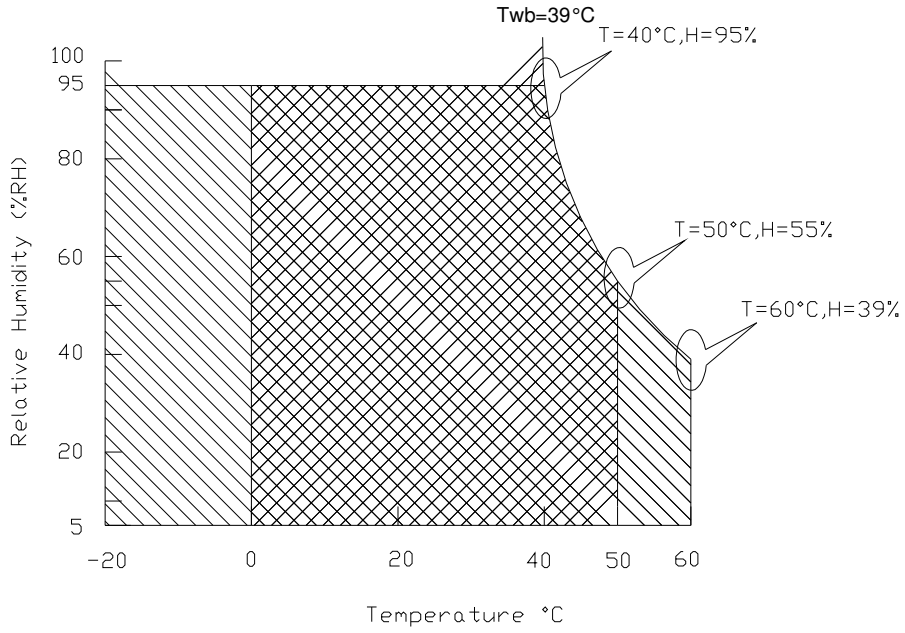
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25℃)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range Storage Range +

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

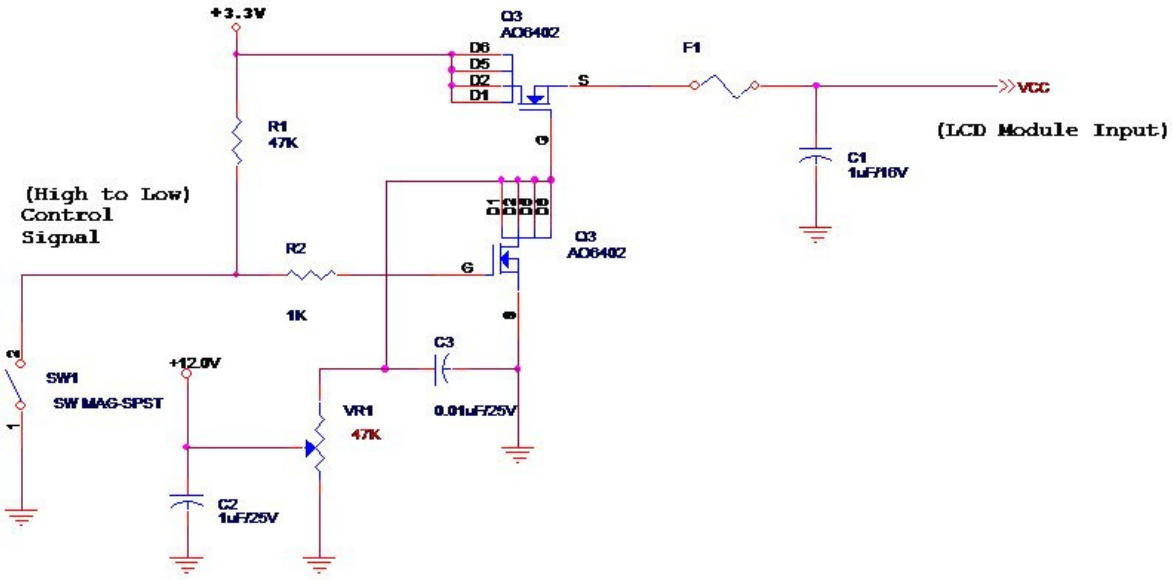
Input power specifications are as follows;

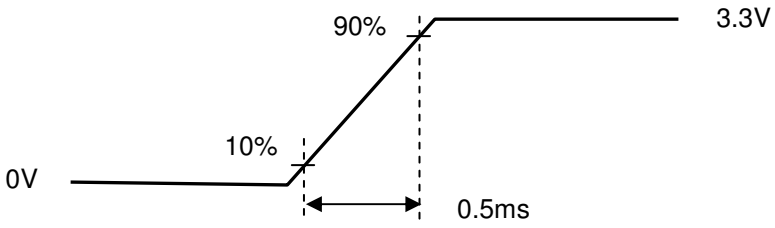
The power specification are measured under 25℃ and frame frenquency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1.5	[Watt]	Note 1
IDD	IDD Current	-	-	500	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. ($P_{max}=V_{3.3} \times I_{black}$)

Note 2 : Measure Condition





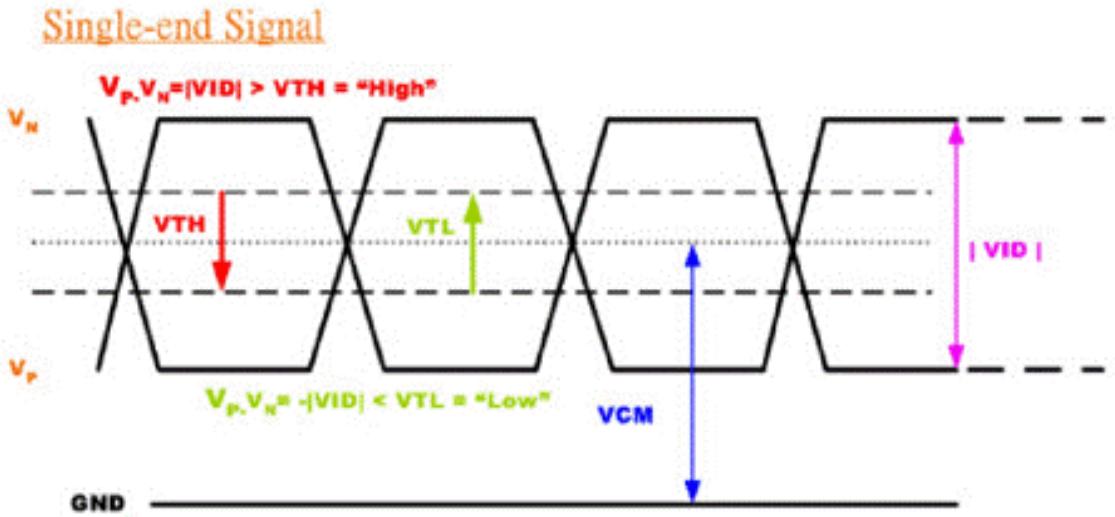
Vin rising time

5.1.2 Signal Electrical Characteristics

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V_{TH}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V_{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V_{CM}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform



5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	3.3	[Watt]	(Ta=25℃), Note 1 Vin =12V
LED Life-Time	N/A	12000	-	-	Hour	(Ta=25℃), Note

Note 1: Calculator value for reference P_{LED} = V_F (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

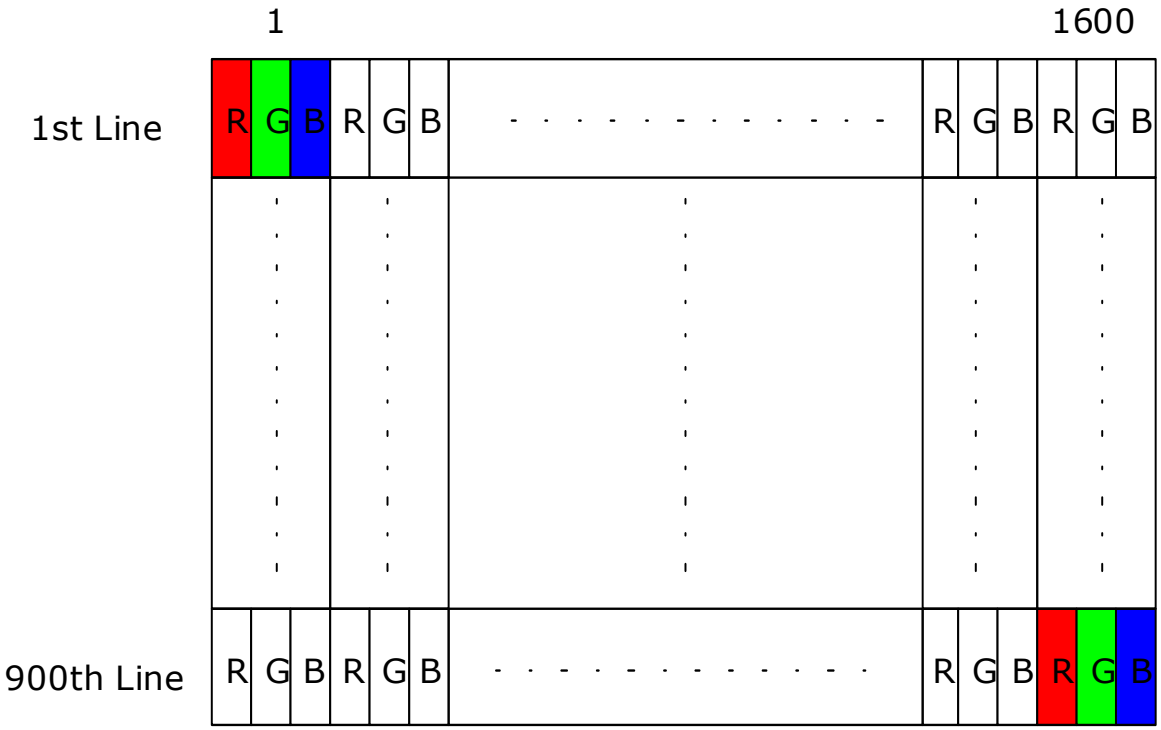
5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25℃)
LED Enable Input High Level	VLED_EN	3	-	5.5	[Volt]	
LED Enable Input Low Level		-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM_EN	3	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.8	[Volt]	
PWM Input Frequency	FPWM	200	-	1K	Hz	
PWM Duty Ratio	Duty	5	--	100	%	

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



6.2 The Input Data Format

Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB) Red-pixel Data	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN .
HS	Horizontal Sync	The signal is synchronized to RxCLKIN .

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	**IPEX or Compatiable**
Type / Part Number	**IPEX 20455-040E-12R or Compatiable**
Mating Housing/Part Number	**IPEX 20453-040T-11 or Compatiable**

6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN #	SIGNAL NAME	DESCRIPTION
1	NC	NC
2	VDD	+ 3.3V Power Supply
3	VDD	+ 3.3V Power Supply
4	VEDID	+ 3.3V EDID Power
5	N.C	No Connect.
6	CLKEDID	EDID Clock Input
7	DATAEDID	EDID Data Input
8	Odd_Rin0-	-LVDS Differential Data Input
9	Odd_Rin0+	+LVDS Differential Data Input
10	VSS	Power Ground
11	Odd_Rin1-	-LVDS Differential Data Input
12	Odd_Rin1+	+LVDS Differential Data Input
13	VSS	Power Ground
14	Odd_Rin2-	-LVDS Differential Data Input
15	Odd_Rin2+	+LVDS Differential Data Input
16	VSS	Power Ground
17	Odd_ClkIN-	-LVDS Differential Clock Input
18	Odd_ClkIN+	+LVDS Differential Clock Input
19	VSS	Ground
20	Even_Rin0-	-LVDS Differential Data Input
21	Even_Rin0+	+LVDS Differential Data Input

22	VSS	Power Ground
23	Even_Rin1-	-LVDS Differential Data Input
24	Even_Rin1+	+LVDS Differential Data Input
25	VSS	Power Ground
26	Even_Rin2-	-LVDS Differential Data Input
27	Even_Rin2+	+LVDS Differential Data Input
28	VSS	Power Ground
29	Even_ClkIN-	-LVDS Differential Clock Input
30	Even_ClkIN+	+LVDS Differential Clock Input
31	VLED_GND	LED_GND
32	VLED_GND	LED_GND
33	VLED_GND	LED_GND
34	NC	NC
35	S-PWM	System PWM signal Input
36	LED_EN	LED enable pin(+3V input, +5V tolerance)
37	NC	NC
38	VLED	LED_Positive (6~21)
39	VLED	LED_Positive(6~21)
40	VLED	LED_Positive(6~21)

Note1: Input signals shall be low or High-impedance state when VDD is off.

6.4 Interface Timing

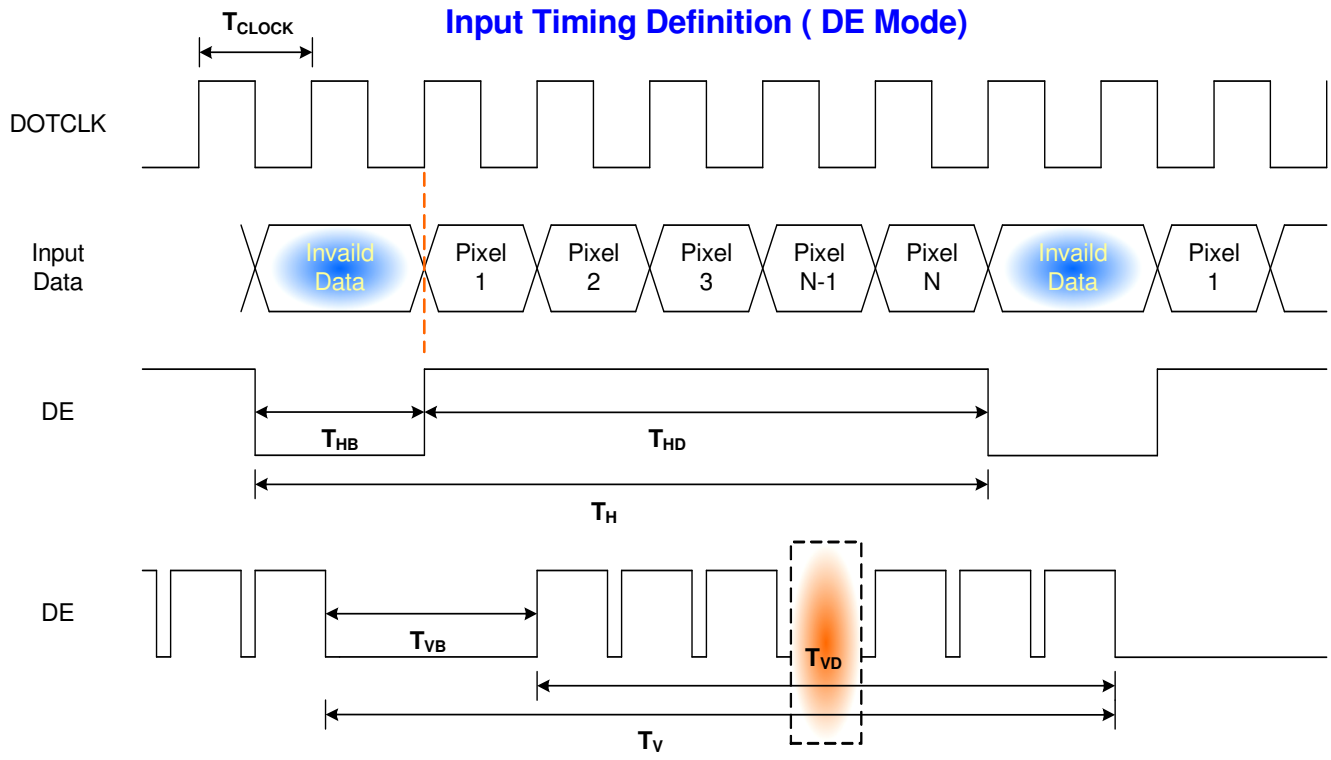
6.4.1 Timing Characteristics

Basically, interface timings should match the 1600x900 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-		60	-	Hz
Clock frequency		1/ T_{Clock}		53.9		MHz
Vertical Section	Period	T_V	908	926	2047	T_{Line}
	Active	T_{VD}	900			
	Blanking	T_{VB}	8	26	-	
Horizontal Section	Period	T_H	1640	1940	2047	T_{Clock}
	Active	T_{HD}	1600			
	Blanking	T_{HB}	40	340		

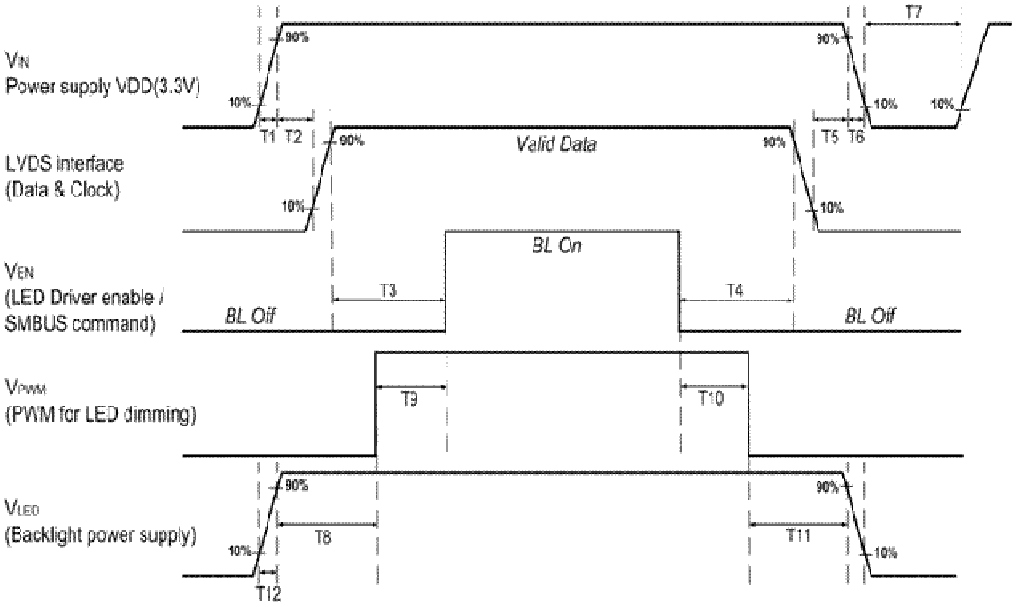
Note : DE mode only

6.4.2 Timing diagram

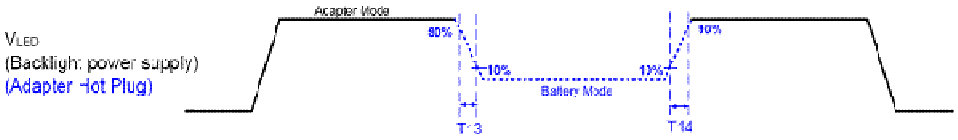


6.5 Power ON/OFF Sequence

VDD power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below:



Power Sequence Timing			
Parameter	Value		Units
	Min.	Max.	
T1	0.5	10	ms
T2	0	50	
T3	200	-	
T4	200	-	
T5	0	50	
T6	0	10	
T7	500	-	
T8	10	-	
T9	10	-	
T10	10	-	
T11	10	-	
T12	0.5	10	
T13	1	-	
T14	1	-	

Seamless change: T13/T14 = 5xT_{PWM}

T_{PWM}= 1/PWM Frequency

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	**Ta= 40℃, 90%RH, 300h**	
High Temperature Operation	**Ta= 50℃, Dry, 300h**	
Low Temperature Operation	**Ta= 0℃, 300h**	
High Temperature Storage	**Ta= 60℃, 35%RH, 300h**	
Low Temperature Storage	**Ta= -20℃, 50%RH, 250h**	
Thermal Shock Test	**Ta=-20℃to 60℃, Duration at 30 min, 100 cycles**	
ESD	**Contact : ±8 KV** **Air : ±15 KV**	Note 1

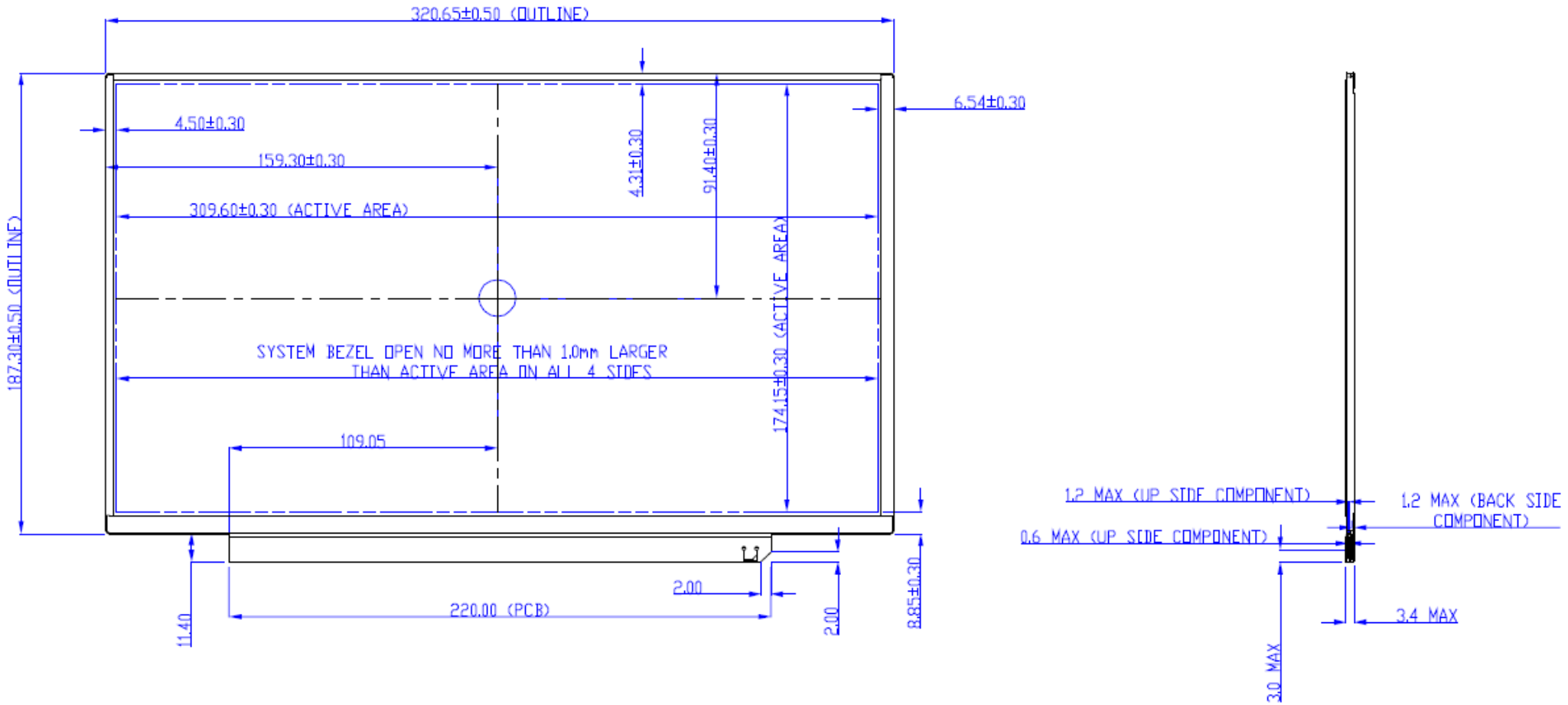
Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. No data lost . Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

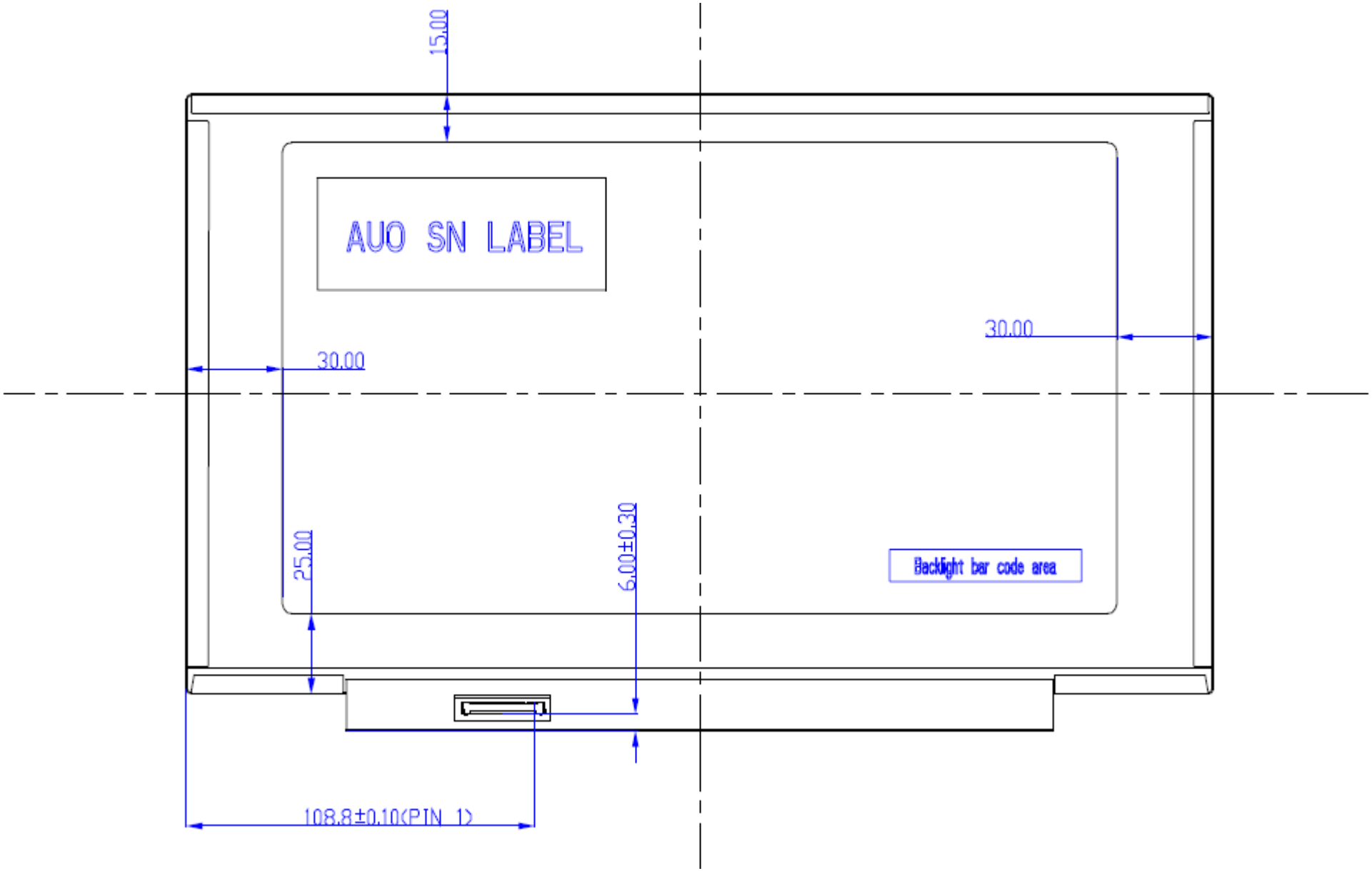
8. Mechanical Characteristics

8.1 LCM Outline Dimension

Front View



Back View



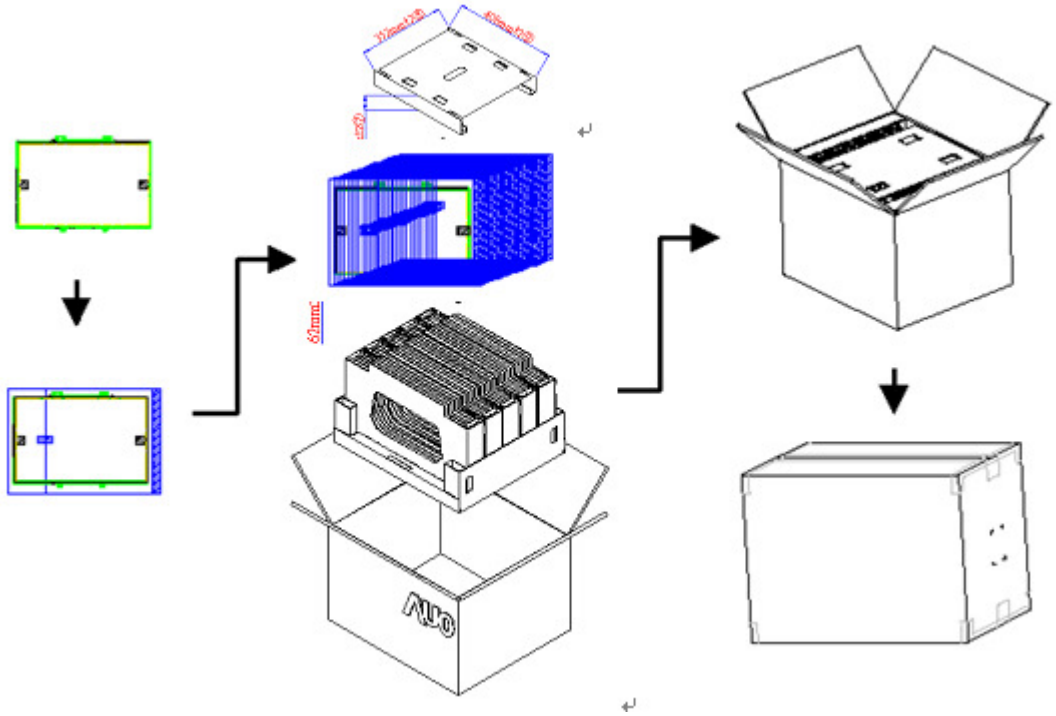
Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

9. Shipping and Package

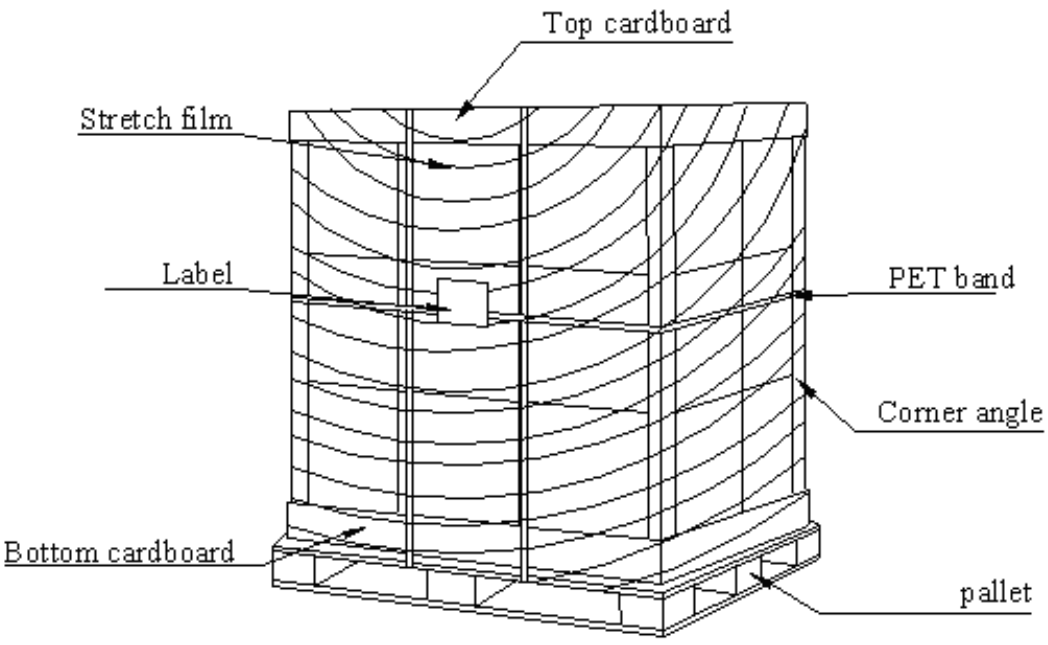
9.1 Shipping Label Format

9.2 Carton Package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



9.3 Shipping Package of Palletizing Sequence



10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value
HEX		HEX	BIN	DEC
00	Header	00	00000000	0
01		FF	11111111	255
02		FF	11111111	255
03		FF	11111111	255
04		FF	11111111	255
05		FF	11111111	255
06		FF	11111111	255
07		00	00000000	0
08	EISA Manuf. Code LSB	06	00000110	6
09	Compressed ASCII	AF	10101111	175
0A	Product Code	3E	00111110	62
0B	hex, LSB first	10	00010000	16
0C	32-bit ser #	00	00000000	0
0D		00	00000000	0
0E		00	00000000	0
0F		00	00000000	0
10	Week of manufacture	00	00000000	0
11	Year of manufacture	15	00010101	21
12	EDID Structure Ver.	01	00000001	1
13	EDID revision #	04	00000100	4
14	**Video input def.** *(digital I/P, non-TMDS, CRGB)*	90	10010000	144
15	**Max H image size** *(rounded to cm)*	1F	00011111	31
16	**Max V image size** *(rounded to cm)*	11	00010001	17
17	**Display Gamma** *(=(gamma*100)-100)*	78	01111000	120
18	**Feature support** *(no DPMS, Active OFF, RGB, tmg Blk#1)*	02	00000010	2
19	Red/green low bits **(Lower 2:2:2:2 bits)**	61	01100001	97
1A	Blue/white low bits **(Lower 2:2:2:2 bits)**	95	10010101	149
1B	Red x **(Upper 8 bits)**	9C	10011100	156
1C	Red y/ highER 8 bits	59	01011001	89
1D	Green x	52	01010010	82
1E	Green y	8F	10001111	143
1F	Blue x	26	00100110	38
20	Blue y	21	00100001	33
21	White x	50	01010000	80
22	White y	54	01010100	84
23	Established timing 1	00	00000000	0
24	Established timing 2	00	00000000	0
25	Established timing 3	00	00000000	0
26	Standard timing #1	01	00000001	1
27		01	00000001	1
28	Standard timing #2	01	00000001	1

29		01	00000001	1
2A	Standard timing #3	01	00000001	1
2B		01	00000001	1
2C	Standard timing #4	01	00000001	1
2D		01	00000001	1
2E	Standard timing #5	01	00000001	1
2F		01	00000001	1
30	Standard timing #6	01	00000001	1
31		01	00000001	1
32	Standard timing #7	01	00000001	1
33		01	00000001	1
34	Standard timing #8	01	00000001	1
35		01	00000001	1
36	Pixel Clock/10000 LSB	1C	00011100	28
37	Pixel Clock/10000 USB	2A	00101010	42
38	Horz active **Lower 8bits**	40	01000000	64
39	Horz blanking **Lower 8bits**	54	01010100	84
3A	HorzAct:HorzBlnk **Upper 4:4 bits**	61	01100001	97
3B	Vertical Active **Lower 8bits**	84	10000100	132
3C	Vertical Blanking **Lower 8bits**	1A	00011010	26
3D	Vert Act : Vertical Blanking **(upper 4:4 bit)**	30	00110000	48
3E	HorzSync. Offset	40	01000000	64
3F	HorzSync.Width	2A	00101010	42
40	VertSync.Offset : VertSync.Width	33	00110011	51
41	Horz&Vert Sync Offset/Width **Upper 2bits**	00	00000000	0
42	Horizontal Image Size **Lower 8bits**	35	00110101	53
43	Vertical Image Size **Lower 8bits**	AE	10101110	174
44	Horizontal & Vertical Image Size **(upper 4:4 bits)**	10	00010000	16
45	Horizontal Border *(zero for internal LCD)*	00	00000000	0
46	Vertical Border *(zero for internal LCD)*	00	00000000	0
47	Signal *(non-intr, norm, no stero, sep sync, neg pol)*	18	00011000	24
48	Pixel Clock/10,000 (LSB)	13	00010011	19
49	Pixel Clock/10,000 (MSB)	1C	00011100	28
4A	Horizontal Addressable Pixels, lower 8 bits	40	01000000	64
4B	Horizontal Blanking Pixels, lower 8 bits	54	01010100	84
4C	H Pixels, upper nibble : H Blanking, upper nibble	61	01100001	97
4D	Vertical Addressable Lines, lower 8 bits	84	10000100	132
4E	Vertical Blanking Lines, lower 8 bits	1A	00011010	26
4F	V lines, upper nibble : V blanking, upper nibble	30	00110000	48
50	Horizontal Front Porch, lower 8 bits	40	01000000	64
51	Horizontal Sync Pulse, lower 8 bits	2A	00101010	42
52	V Front Porch, lower nibble : V Sync Pulse, lower nibble	33	00110011	51
53	VFP, 2 bits: VSP 2 bits: HFP 2 bits: HFP 2 bits	00	00000000	0
54	Horizontal Image Size in mm, lower 8 bits	35	00110101	53

55	Vertical Image Size in mm, lower 8 bits	AE	10101110	174
56	H Image Size, upper nibble : V Image Size, upper nibble	10	00010000	16
57	Horizontal Border	00	00000000	0
58	Vertical Border	00	00000000	0
59	Bit Encode Sync Information	18	00011000	24
5A	DC	00	00000000	0
5B	HTOTAL	00	00000000	0
5C	HA	00	00000000	0
5D	HBL	00	00000000	0
5E	HFP	00	00000000	0
5F	HFPe	00	00000000	0
60	HBP	00	00000000	0
61	HB	00	00000000	0
62	HSO	00	00000000	0
63	HS	00	00000000	0
64	VTOTAL	00	00000000	0
65	VA	00	00000000	0
66	VBL	00	00000000	0
67	VFP	00	00000000	0
68	VBP	00	00000000	0
69	VB	00	00000000	0
6A	VSO	00	00000000	0
6B	VS	00	00000000	0
6C	Detail Timing Description #4	00	00000000	0
6D	Flag	00	00000000	0
6E	Reserved	00	00000000	0
6F	For Brightness Table and Power Consumption	02	00000010	2
70	Flag	00	00000000	0
71	PWM % [7:0] @ Step 0	0C	00001100	12
72	PWM % [7:0] @ Step 5	3C	00111100	60
73	PWM % [7:0] @ Step 10	F9	11111001	249
74	Nits [7:0] @ Step 0	0A	00001010	10
75	Nits [7:0] @ Step 5	3C	00111100	60
76	Nits [7:0] @ Step 10	7D	01111101	125
77	Panel Electronics Power @ 32x32 Chess Pattern =	14	00010100	20
78	Backlight Power @ 60 nits =	12	00010010	18
79	Backlight Power @ Step 10 =	26	00100110	38
7A	Nits @ 100% PWM Duty =	81	10000001	129
7B	Flag	20	00100000	32
7C	Flag	20	00100000	32
7D	Flag	20	00100000	32
7E	Extension Flag	00	00000000	0
7F	Checksum	6A	01101010	106